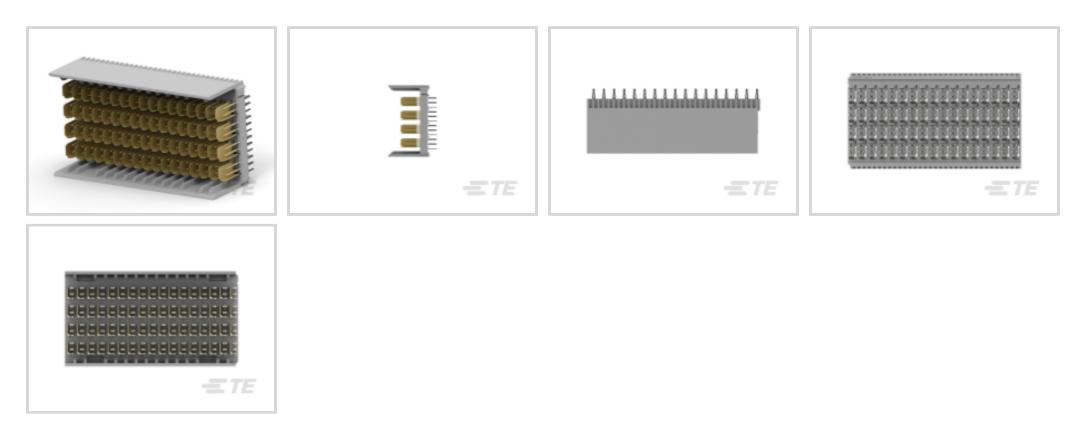


Z-PACK | Z-PACK HM-Zd

TE Internal #: 6469002-1 High Speed Backplane Connectors, Board-to-Board, 80 Position, Mating Alignment, Guide Lugs Mating Alignment Type, 8 Row, 10 Column, Z-PACK HM-Zd

View on TE.com >

Connectors > PCB Connectors > Backplane Connectors > High Speed Connectors



Connector System: Board-to-Board Number of Positions: 80 Row-to-Row Spacing: 1.5 mm [.059 in] Mating Alignment: With

Mating Alignment Type: Guide Lugs

Features



Product Type Features

Connector System	Board-to-Board		
PCB Connector Assembly Type	PCB Mount Header		
Shroud Style	Partially Shrouded		
Sealable	No		
Connector & Contact Terminates To	Printed Circuit Board		
Configuration Features			
Pairs per Column	4		
Number of Ground Positions	40		
Card Slot Centerline	25.4 mm[1 in]		
Number of Pairs	40		
Number of Signal Positions	80		
Number of Positions	80		
Number of Rows	8		
Number of Columns	10		

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PCB Mount Orientation	Vertical
Guide Location	Unguided
Electrical Characteristics	
Operating Voltage	250 VAC
Signal Characteristics	
Data Rate	≤12 Gb/s
Body Features	
Shield Material	Phosphor Bronze
Contact Features	
Contact Layout	Matrix
Contact Mating Area Length	5.3 mm[.21 in]
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	.7 A

Termination Features

Termination Post & Tail Length	2.5 mm[.098 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Guide Lugs
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Polyester - GF
Housing Color	Gray
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	24.9 mm[.98 in]
Connector Height	13.4 mm[.527 in]
Connector Width	23.43 mm[.922 in]
Row-to-Row Spacing	1.5 mm[.059 in]

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Usage Conditions

Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]					
Operation/Application						
Circuit Application	Signal					
Industry Standards						
UL Flammability Rating	UL 94V-0					
Packaging Features						
Packaging Method	Tube					
Product Compliance For compliance documentation, visit the product page on TE.com>						
EU RoHS Directive 2011/65/EU	Compliant					
EU ELV Directive 2000/53/EC	Compliant					
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold					
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223)					

SVHC > Threshold: Not Yet Reviewed

Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Halogen Content

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

High Speed Backplane Connectors, Board-to-Board, 80 Position, Mating Alignment, Guide Lugs Mating Alignment Type, 8 Row, 10 Column, Z-PACK HM-Zd







TE Part # 2227510-1 HM-ZD 4PR RECP 80P 50Au

Also in the Series Z-PACK HM-Zd





Hard Metric Backplane Connectors(1)	High Spe	eed Backplane Connecto	ors(46)	Insertion & Extraction Too	ols(2)

Customers Also Bought



High Speed Backplane Connectors, Board-to-Board, 80 Position, Mating Alignment, Guide Lugs Mating Alignment Type, 8 Row, 10 Column, Z-PACK HM-Zd



TE Part #2838892-3 192CEX_32C44 CABLE ASSY_MP002

Documents

Product Drawings HM-ZD 4PR HDR 80P 5.2MM

English

CAD Files

Customer View Model ENG_CVM_CVM_6469002-1_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_6469002-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_6469002-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK HM-Zd Connector

English

The Complete Solution for AdvancedTCA

English

High Speed Backplane Interconnect Solutions Brochure 1654263-1

English

Solutions for AdvancedTCA, AdvancedTCA 300, MicroTCA, and AdvancedMC Standards Datasheet 3-1773445-8

English

Product Specifications
Application Specification

English

Product Environmental Compliance MD_6469002-1_08232017959_dmtec

English

MD_6469002-1_08232017959_dmtec

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English